

Single N-channel MOSFET

ELM32404LA-S

■General description

ELM32404LA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds}=30V$
- $I_d=12A$
- $R_{ds(on)} < 25m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 37m\Omega$ ($V_{gs}=4.5V$)

■Maximum absolute ratings

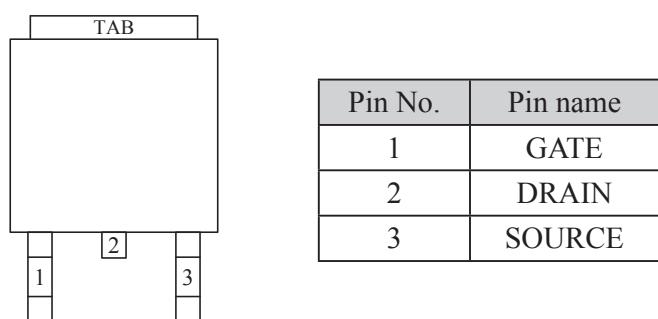
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current	I_d	12	A	3
		10		
Pulsed drain current	I_{dm}	30	A	3
Power dissipation	P_d	32	W	
		22		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

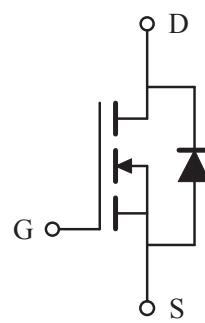
Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-case	$R_{\theta jc}$		3	°C/W	
Maximum junction-to-ambient	$R_{\theta ja}$		75	°C/W	

■Pin configuration

TO-252-3(TOP VIEW)



■Circuit



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■Electrical characteristics

T_a=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BV _{dss}	Id=250μA, V _{gs} =0V	30			V	
Zero gate voltage drain current	Id _{ss}	V _{ds} =24V, V _{gs} =0V			1	μA	
		V _{ds} =20V, V _{gs} =0V, T _j =55°C			10		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±20V			±250	nA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , Id=250μA	1.0	1.5	2.5	V	
On state drain current	I _{d(on)}	V _{gs} =10V, V _{ds} =5V	30			A	1
Static drain-source on-resistance	R _{d(on)}	V _{gs} =10V, Id=12A		18	25	mΩ	1
		V _{gs} =4.5V, Id=6A		25	37	mΩ	
Forward transconductance	G _{fs}	V _{ds} =5V, Id=12A		19		S	1
Diode forward voltage	V _{sd}	I _f =1A, V _{gs} =0V			1	V	1
Max. body-diode continuous current	I _s				1.3	A	
Pulsed body-diode current	I _{sm}				2.6	A	3
DYNAMIC PARAMETERS							
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =10V, f=1MHz		790		pF	
Output capacitance	C _{oss}			175		pF	
Reverse transfer capacitance	C _{rss}			65		pF	
SWITCHING PARAMETERS							
Total gate charge	Q _g	V _{gs} =10V, V _{ds} =15V, Id=12A		16.0		nC	2
Gate-source charge	Q _{gs}			2.5		nC	2
Gate-drain charge	Q _{gd}			2.1		nC	2
Turn-on delay time	t _{d(on)}	V _{gs} =10V, V _{ds} =10V, Id≈1A R _{gen} =6Ω		2.2	4.4	ns	2
Turn-on rise time	t _r			7.5	15.0	ns	2
Turn-off delay time	t _{d(off)}			11.8	21.3	ns	2
Turn-off fall time	t _f			3.7	7.4	ns	2

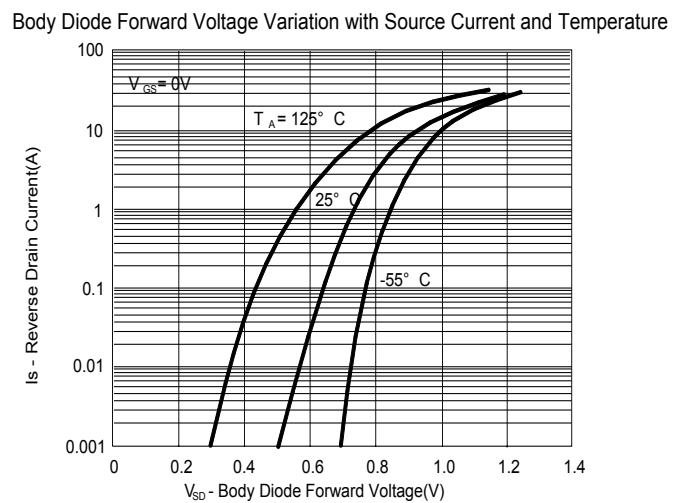
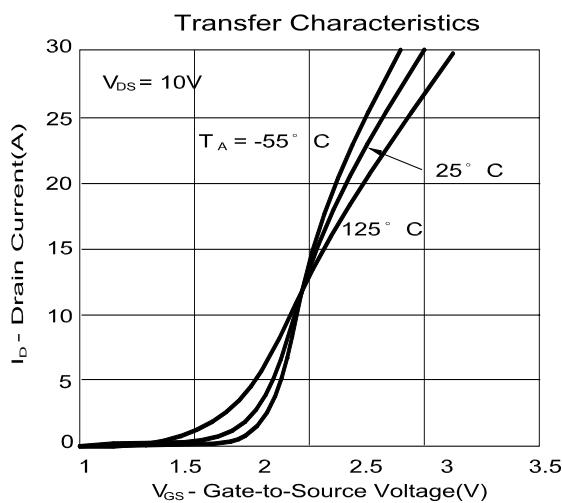
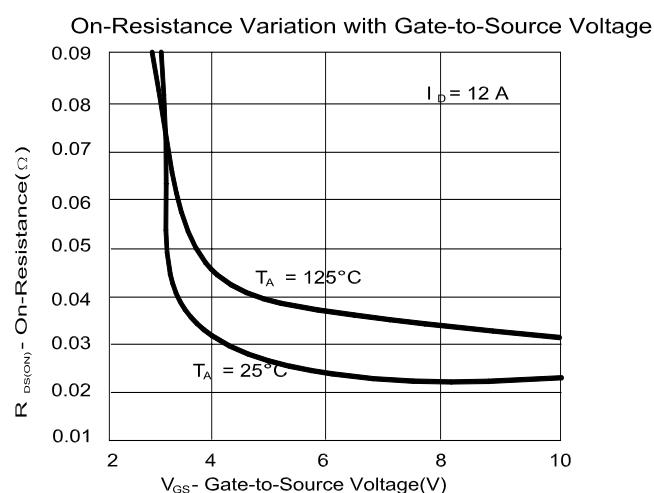
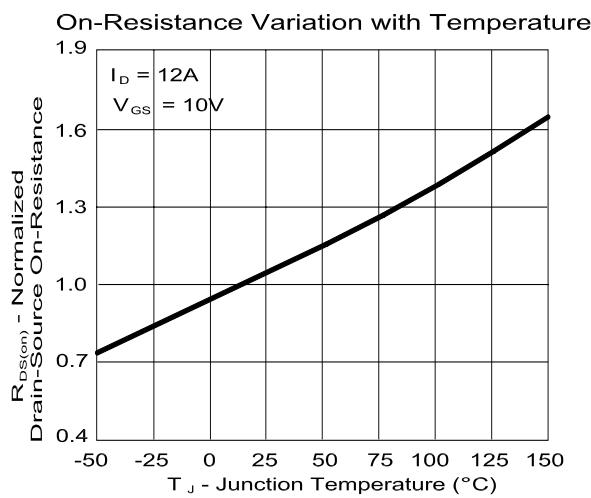
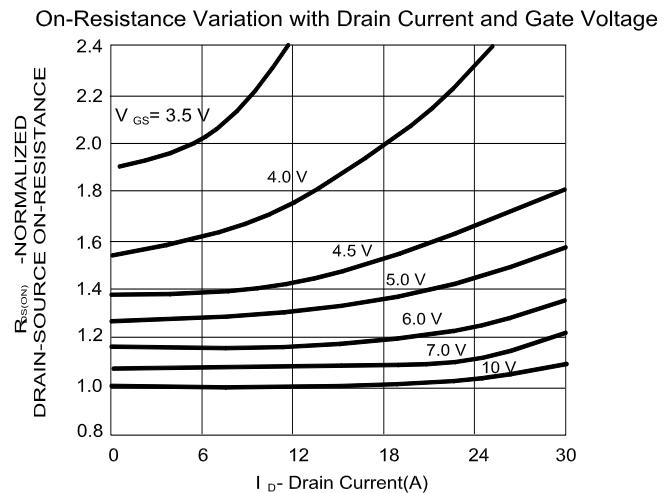
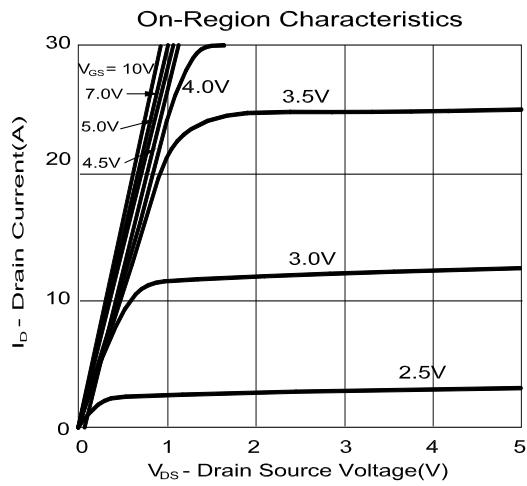
NOTE :

1. Pulse test : Pulsed width ≤ 300μsec and Duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulsed width limited by maximum junction temperature.
4. Duty cycle ≤ 1%.

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■ Typical electrical and thermal characteristics



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